

Title (en)

DEVICE FOR CUTTING THROUGH AN ADHESIVE STRIP AND METHOD FOR PREPARING AN ADHERING LOCATION

Title (de)

VORRICHTUNG ZUM DURCHTRENNEN EINES KLEBEPLANDES UND VERFAHREN ZUR VORBEREITUNG EINER KLEBESTELLE

Title (fr)

DISPOSITIF POUR SECTIONNER UNE BANDE ADHESIVE ET PROCEDE POUR PREPARER UN EMPLACEMENT DE COLLAGE

Publication

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Application

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Priority

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Abstract (en)

[origin: WO03008310A1] The invention relates to a device (08) for cutting through an adhesive strip (06) which, on at least one side, is provided with an adhesive layer (11) that is covered by a covering strip (12). Said device comprises a conveying unit (04, 18) by means of which the adhesive strip (06) can be conveyed into an adhering zone (09), and comprises a cutting implement (21) with which the adhesive strip (06) can be cut through in a cutting zone (19). The cutting implement (21) is designed whereby enabling the adhesive strip (06) to be cut through while preserving a connection of the covering strip (12), which rests on the adhesive strip, over the cutting zone (19). The invention also relates to a method for preparing an adhering location.

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